AUTOMOTIVE

COMPLIANT

HALOGEN

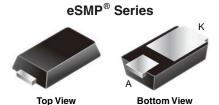
FREE



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Vishay General Semiconductor

Surface-Mount Ultrafast Rectifiers



MicroSMP (DO-219AD)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V _{RRM}	100 V, 150 V			
I _{FSM}	10 A			
t _{rr}	25 ns			
V _F at I _F = 1.0 A	0.82 V			
I _R	1 μΑ			
T _J max.	175 °C			
Package	MicroSMP (DO-219AD)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low power losses
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds AC/AC and DC/DC converters.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and automotive grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	MUH1PB	MUH1PC	UNIT		
Device marking code		НВ	HC			
Maximum repetitive peak reverse voltage	V _{RRM}	100 150		V		
Maximum average forward rectified current (fig. 1)	I _{F(AV)}	1.0		А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	10		А		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175		°C		

Revision: 04-Aug-2020 **1** Document Number: 89124 For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u>





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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum instantaneous forward voltage	I _F = 0.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.90	-		
	I _F = 1.0 A			1.0	1.05		
	I _F = 0.5 A	T _A = 125 °C		0.72	-	7 °	
	I _F = 1.0 A			0.82	0.90	7	
Maximum reverse current	Pated V	T _A = 25 °C	I _R ⁽²⁾	-	1.0		
	Rated V _R	T _A = 125 °C		3.0	15	μA	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$	T 05 °C		19	25		
Typical reverse recovery time	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$	T _A = 25 °C	t _{rr}	29	40	ns	
Typical softness factor (t _b /t _a)			S	0.5	-		
Typical reverse recovery current	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 200 \text{ A/}\mu\text{s},$ $V_B = 200 \text{ V}$	T _A = 125 °C	I _{RM}	3.4	4.6	Α	
Typical stored charge			Q _{rr}	45	-	nC	
Typical junction capacitance	4.0 V, 1 MHz		CJ	10	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	MUH1PB MUH1PC MUH1PD					
Typical thermal resistance	R _{0JA} (1)	166			°C/W		
Typical thermal resistance	R _{0JM} (1)	40			C/VV		

Note

 $^{(1)} \ \ \text{Free air, mounted on recommended copper pad area. Thermal resistance } \ R_{\theta JA} \ \text{- from junction to ambient, } \ R_{\theta JM} \ \text{- and junction to mount}$

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
MUH1PC-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel			
MUH1PCHM3/89A (1)	0.006	89A	4500	7" diameter plastic tape and reel			

Note

(1) Automotive grade



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

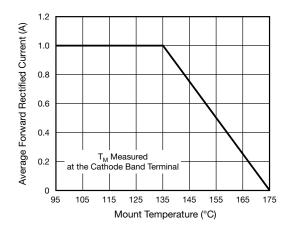


Fig. 1 - Maximum Forward Current Derating Curve

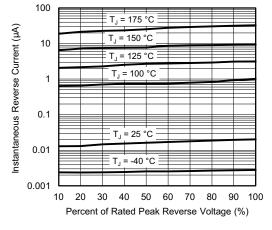


Fig. 4 - Typical Reverse Characteristics

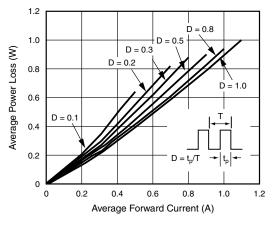


Fig. 2 - Forward Power Loss Characteristics

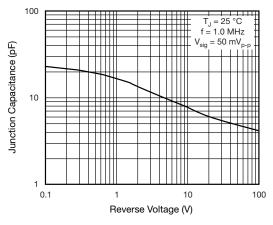


Fig. 5 - Typical Junction Capacitance

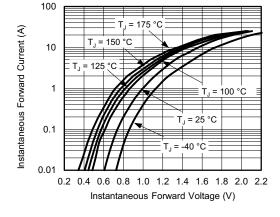


Fig. 3 - Typical Instantaneous Forward Characteristics

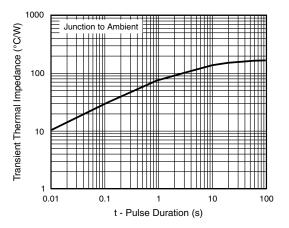


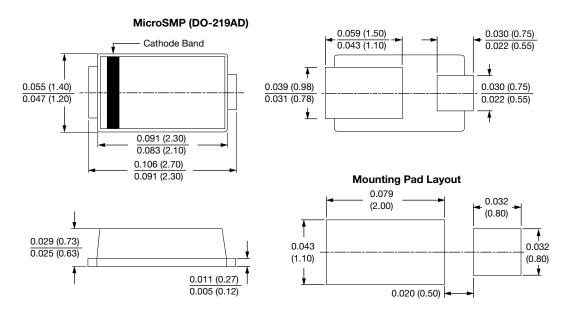
Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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